



J	SHELL	1	SUS T=0.20	NI ALL OVER 50u"Min
H	SEPARATOR	1	HIGH TEMP.THERMOPLASTIC UL94V-0	BLACK
G	MAKE TERMINAL	1	COPPY ALLOY T=0.2mm	
F	TRANSFER TERMINAL	1	COPPY ALLOY T=0.2mm	GOLD PLATED ON THE CONTACT AREA , GOLD FLASH ON THE SOLDER AREA; ALLOVER 50u" Ni.
E	TIP SPRING	1	SUS. T=0.2mm	
D	RING-A	1	COPPY ALLOY T=0.2mm	
C	RING-B	1	COPPY ALLOY T=0.2mm	
B	EARTH	1	COPPY ALLOY T=0.2mm	Pd/Ni 1~3u" ON THE CONTACT AREA , GOLD FLASH ON THE SOLDER AREA; ALLOVER 50u" Ni.
A	HOUSING	1	HIGH TEMP.THERMOPLASTIC UL94V-0	DSM stanyl HFX61S V2 Black BK27043
NO.	PART NAME		MATERIAL	

X.± 0.20	X°± 5°	UNITS	mm	NAME(INTENDED USE) φ3.5mm AUDIO JACK CONN	oln ^o 东莞市欧联电子科技有限公司 DONGGUAN OLN ELECTRONICS TECHNOLOGY CO., LTD.	
.X± 0.15	.X°± 2°	MAT'L				
.XX± 0.08	.XX°± 1°	FINISH		PART NO.(INTENDED USE) AJ081-BM401-**	TITLE: φ3.5mm AUDIO JACK CONN(AJ081)	
.XXX± 0.05	.XXX°± 0.5°		Q'TY		APPD: CHKD: DR: Qiang 2021-04-13	DWG NO.: AJ081-BM401-00
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				1:1	1/2	A

- 备注:
- 电气性能:
 - 1-1. 接触阻抗: 50m Ω 最大(初始), 100m Ω 最大(测试后)
 - 1-2. 耐压测试: 500V AC 一分钟.
 - 1-3. 绝缘阻抗: 100M Ω 最小, 测试电压500V直流
 - 机械性能:
 - 2-1. 公头插入力: 0.8~2.4kgf.
 - 2-2. 公头拔出力: 0.8~2.4kgf.
 - 2-3. 寿命后公头插入力: 0.6~2.4kgf.
 - 2-4. 寿命后公头拔出力: 0.6~2.4kgf.
 - 寿命测试 5,000次.
 - 用于回流焊无铅工艺.
 - 抗回流焊焊接温度 260°C.
 - 使用公头应符合协会规范 EIAJ RC-5325 SPEC.
 - 包装方式: 载带卷盘.
 - 产品需符合无铅和无卤要求.
 - 重点尺寸: ▼